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# 4V+2.5V Drive Nch+Pch MOSFET

## US6M1

#### Structure

Silicon N-channel / P-channel MOSFET

#### Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TUMT6).

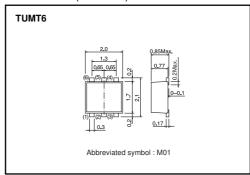
## Application

Power switching, DC / DC converter.

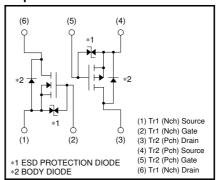
## Packaging specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
US6M1		0

## ●Dimensions (Unit:mm)



## ●Equivalent circuit



## ● Absolute maximum ratings (Ta=25°C)

Parameter		Cumbal	Lin	Unit	
		Symbol	Tr1: Nchannel	Tr2 : Pchannel	Oill
Drain-source voltage		VDSS	30	-20	V
Gate-source voltage		$V_{GSS}$	20	-12	V
Drain current	Continuous		±1.4	±1	Α
Diam current	Pulsed	IDP*1	±5.6	±4	Α
Source current	Continuous	Is	0.6	-0.4	Α
(Body diode) Pulsed		Isp*1	5.6	-4	Α
Total power dissipation		D- *2	Pn*2 1		W / TOTAL
		Fυ	0.7		W / ELEMENT
Channel temperature		Tch	150		°C
Storage temperature		Tstg	-55 to +150		°C

<sup>\*1</sup> Pw≤10µs, Duty cycle≤1% \*2 Mounted on a ceramic board.

### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)*	125	°C / W /TOTAL
Charmer to ambient	niii (Cii-a)	179	°C / W / ELEMENT
*2 Mounted on a ceramic board.			

N-ch ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	_	10	μΑ	Vgs=20V, Vps=0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	30	_	_	٧	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	_	_	1	μΑ	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	1.0	_	2.5	V	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
		_	170	240		I <sub>D</sub> =1.4A, V <sub>GS</sub> =10V
Static drain-source on-state resistance	R <sub>DS (on)</sub>	_	250	350	mΩ	I <sub>D</sub> =1.4A, V <sub>GS</sub> =4.5V
resistance		-	270	380		I <sub>D</sub> =1.4A, V <sub>GS</sub> =4V
Forward transfer admittance	Y <sub>fs</sub> *	1.0	_	-	S	I <sub>D</sub> =1.4A, V <sub>DS</sub> =10V
Input capacitance	Ciss	_	70	_	pF	V <sub>DS</sub> =10V
Output capacitance	Coss	_	15	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	12	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	6	_	ns	I <sub>D</sub> =0.7A, V <sub>DD</sub> ≒15V
Rise time	tr *	_	6	_	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d (off)</sub> *	_	13	_	ns	R <sub>L</sub> =21Ω
Fall time	t <sub>f</sub> *	-	8	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	-	1.4	2.0	nC	V <sub>DD</sub> ≒15V R <sub>L</sub> =11Ω
Gate-source charge	Q <sub>gs</sub> *	-	0.6	-	nC	$V_{GS}=5V$ $R_{G}=10\Omega$
Gate-drain charge	Q <sub>gd</sub> *	-	0.3	_	nC	I <sub>D</sub> =1.4A

<sup>\*</sup>Pulsed

## ●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Forward voltage	V <sub>SD</sub>	_	_	1.2	٧	I <sub>S</sub> =0.6A, V <sub>GS</sub> =0V

P-ch
●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	-10	μА	Vgs=12V, Vps=0V
Drain-source breakdown voltage	V <sub>(BR) DSS</sub>	-20	_	_	٧	I <sub>D</sub> =-1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	V <sub>DS</sub> = -20V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-0.7	_	-2.0	٧	$V_{DS} = -10V, I_{D} = -1mA$
Otation during a service and attack		-	280	390		I <sub>D</sub> = -1A, V <sub>G</sub> S= -4.5V
Static drain-source on-state resistance	R <sub>DS (on)</sub> *	_	310	430	mΩ	I <sub>D</sub> =-1A, V <sub>G</sub> S=-4V
resistance		_	570	800		$I_D = -0.5A$ , $V_{GS} = -2.5V$
Forward transfer admittance	Y <sub>fs</sub> *	0.7	_	_	S	$I_D = -0.5A$ , $V_{DS} = -10V$
Input capacitance	Ciss	_	150	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	_	20	_	pF	V <sub>G</sub> S=0V
Reverse transfer capacitance	Crss	_	20	_	pF	f=1MHz
Turn-on delay time	t <sub>d (on)</sub> *	-	9	_	ns	I <sub>D</sub> = −0.5A, V <sub>DD</sub> ≒ −15V
Rise time	tr *	_	8	_	ns	V <sub>GS</sub> = -4.5V
Turn-off delay time	td (off) *	-	25	_	ns	R <sub>L</sub> =30Ω
Fall time	t <sub>f</sub> *	-	10	_	ns	R <sub>G</sub> =10Ω
Total gate charge	Qg *	_	2.1	_	nC	V <sub>DD</sub> ≒ −15V R <sub>L</sub> =15Ω
Gate-source charge	Q <sub>gs</sub> *	_	0.5	_	nC	$V_{GS}=-4.5V$ $R_{G}=10\Omega$
Gate-drain charge	Q <sub>gd</sub> *	-	0.5	-	nC	I <sub>D</sub> = -1A

<sup>\*</sup>Pulsed

## ●Body diode characteristics (Source-Drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Forward voltage	V <sub>SD</sub>	_	_	-1.2	٧	$I_S = -0.4A, V_{GS} = 0V$

## N-ch •Electrical characteristic curves

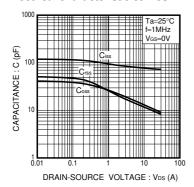


Fig.1 Typical Capacitance vs. Drain-Source Voltage

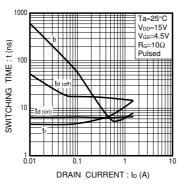


Fig.2 Switching Characteristics

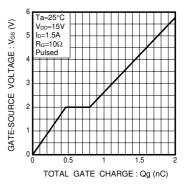


Fig.3 Dynamic Input Characteristics

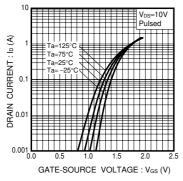


Fig.4 Typical Transfer Characteristics

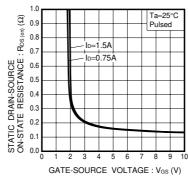


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

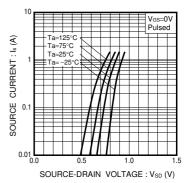


Fig.6 Source Current vs. Source-Drain Voltage

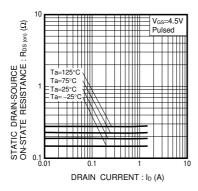


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

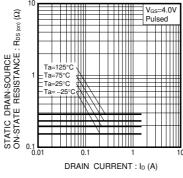


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

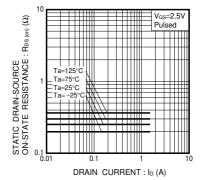


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

## P-ch •Electrical characteristic curves

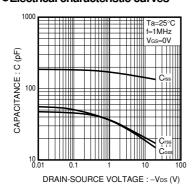


Fig.1 Typical Capacitance vs. Drain-Source Voltage

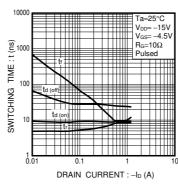


Fig.2 Switching Characteristics

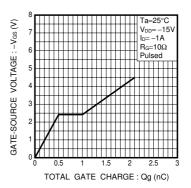


Fig.3 Dynamic Input Characteristics

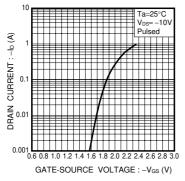


Fig.4 Typical Transfer Characteristics

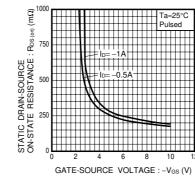


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

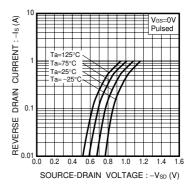


Fig.6 Source Current vs. Source-Drain Voltage

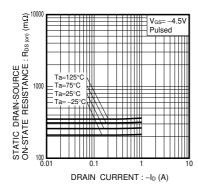


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

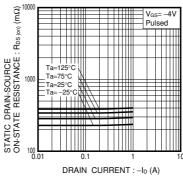


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

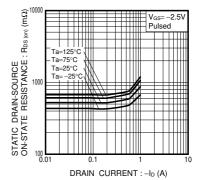


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

## N-ch

## ●Measurement circuit

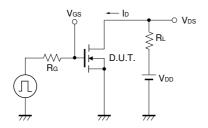


Fig.1-1 Switching Time Measurement Circuit

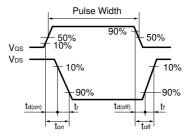


Fig.1-2 Switching Waveforms

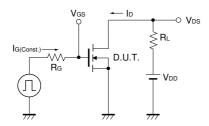


Fig.2-1 Gate Charge Measurement Circuit

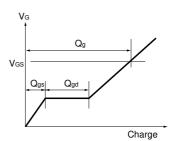


Fig.2-2 Gate Charge Waveform

## P-ch

## ●Measurement circuit

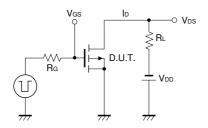


Fig.3-1 Switching Time Measurement Circuit

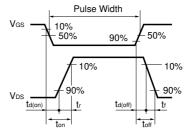


Fig.3-2 Switching Waveforms

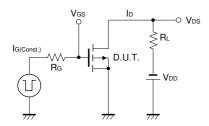


Fig.4-1 Gate Charge Measurement Circuit

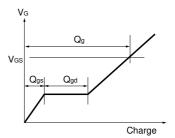


Fig.4-2 Gate Charge Waveform

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## US6M1 - Web Page

**Distribution Inventory** 

Part Number	US6M1
Package	TUMT6
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes